

CALL FOR PAPER

Prague, Czech Republic
FEB. 16-19, 2019

SUBMISSION
UNTIL
DEC. 10

ICMEP 2019

The 8th International Conference on
Manufacturing Engineering and Processes

ICMEP 2019 Conference papers will get published by SSP Proceedings, indexed by EI Compendex, Scopus, etc.

Contact:

Secretary: Celine XI/Email: icmep@sciei.org/Tel.: +861-820-777775/+1-562-606-1057
www.icmep.org



ICMEP 2019

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About ICMEP

ICMEP, is an annual conference organized with the intend of being a platform for researchers, engineers, academicians as well as industrial professionals from all over the world to present their research results and development activities in Manufacturing Engineering and Process. This conference provides opportunities for the delegates to exchange new ideas and application experiences face to face, to establish business or research relations and to find global partners for future collaboration.

Important Dates

Submission Deadline: Dec. 10, 2018;
Notification Date: Dec. 25, 2018;
Deadline Date: Jan. 10, 2019.

Publication

Accepted papers will be published into SSP conference proceedings, to be indexed by EI Compendex, Scopus, etc.

Submission Way

Submit via EasyChair:
<http://www.easychair.org/conferences/?conf=icmep2019>
For any further inquiry, please contact icmep@sciei.org

Topics

Included but not limited:

- Casting and solidification
- Coatings and surface engineering
- Composite materials
- Computer-aided design, manufacturing, and engineering
- Environmentally sustainable manufacturing processes and systems
- Joining processes
- Laser based manufacturing
- Manufacturing process planning and scheduling
- Materials behavior
- Materials forming
- Metrology and measurement
- Modeling, analysis, and simulation of manufacturing processes
- Nanofabrication, nanometrology and applications
- Nanomaterials and nanomanufacturing
- Nontraditional manufacturing
- Physics
- Powder metallurgy and ceramic forming
- Precision molding processes
- Rapid manufacturing technologies
- Semiconductor materials manufacturing
- Surface, subsurface, and interface phenomena

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The 8th International Conference on Manufacturing Engineering and Processes

Organizing Committee

Conference Chairs

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Ramesh K. Agarwal, Washington University in St. Louis, USA

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Muhammad Fahad, NEDUET Karachi Pakistan, Pakistan
Kodakkal Kannan Viswanathan, Kuwait College of Science and Technology, Kuwait
Mehmet Karakose, Firat University, Turkey

History

ICMEP 2018, Barcelona, Spain, Feb. 5-7, 2018
Proceedings published on TTP-SSP, ISBN: 978-3-0357-1370-1
ICMEP 2017, Lisbon, Portugal, May 27-29, 2017
Proceedings published on IOP, ISSN: 1742-6588, VOL. 885
ICMEP 2016, Istanbul, Turkey, May 25-27, 2016
Proceedings published on MSF, ISBN: 978-3-03835-778-0
ICMEP 2015, Paris, France, April 13-14, 2015
Proceedings published on TTP-AMM: ISBN:978-3-03835-543-4
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Contact

Conference secretary: Celine XI
Email: icmep@sciei.org
Tel.: +86-18207777775/+1-562-606-1057
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